



Docket No.: M4065.0222/P222-B  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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In re Patent Application of:  
Tongbi Jiang

Application No.: 10/667,391

Confirmation No.: 1655

Filed: September 23, 2003

Art Unit: 2829

For: METHOD OF MAKING A CENTER BOND  
FLIP CHIP SEMICONDUCTOR CARRIER  
(as amended)

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Examiner: S. B. Geyer

**AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated November 15, 2005, please amend the above-identified U.S. patent application as follows:

**Amendments to the Specification** begin on page 2 of this paper.

**Remarks** begin on page 3 of this paper.